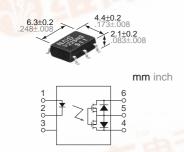




## RF (Radio Frequency) Type SOP Series [1-Channel (Form A) Type] —Low On resistance—

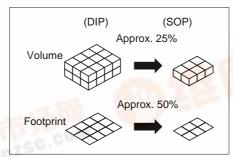
## PhotoMOS RELAYS



#### **FEATURES**

#### 1. 1-channel (Form A) in super miniature design

The device comes in a super-miniature SO package measuring (W)  $4.4 \times (L)$  6.3  $\times (H)$  2.1 mm (W).173 $\times$  (L) .248 $\times$  (H) .083 inch —approx. 25% of the volume and 50% of the footprint size of DIP type PhotoMOS Relays.



# 2. Low capacitance between output terminals ensure high response speed:

The capacitance between output terminals is small, typically 10 pF. This enables for a fast operation speed of 200 µs.

3. Low-level off state leakage current: The SSR has an off state leakage current of several milliamperes, whereas the PhotoMOS relay has only 30 pA even with the rated load voltage of 80 V (AQV225NS).

# 4. Controls low-level analog signals PhotoMOS relays feature extremely low closed-circuit offset voltage to enable control of low-level analog signals without distortion.

#### 5. Tape and reel

The device comes standard in a tape and reel (1,000 pcs./reel) to facilitate automatic insertion machines.

#### TYPICAL APPLICATIONS

- Telephones
- Measuring instruments
- Computer
- Industrial robots
- High-speed inspection machines

#### **TYPES**

#### 1. AC/DC type

Output rating*		Par				
		Picked from the 1/2/3-pin side	Picked from the 4/5/6-pin side	Packing quantity in tape and reel		
Load voltage	Load current	d current 1 Form A 1 Form A		-7 574		
80 V	120 mA	AQV225NSX	AQV225NSZ	一名物門		
200 V	50 mA	AQV227NSX	AQV227NSZ	1,000 pcs.		
400 V 40 mA		AQV224NSX	AQV224NSZ	- W.075		

<sup>\*</sup>Indicate the peak AC and DC values.

Notes: (1) Tape package is the standard packing style. Also available in tube. (Part No. suffix "X" or "Z" is not needed when ordering; Tube: 75 pcs.; Case: 1,500 pcs.)

(2) For space reasons, the top two letters of the product number "AQ" are omitted on the product seal. The package type indicator "X" and "Z" are also omitted from the seal. (Ex. the label for product number AQV224NS is V224NS).

#### RATING

1. Absolute maximum ratings (Ambient temperature: 25°C 77°F)

	Ů (			,			
	Item	Symbol	Type of connection	AQV225NS	AQV227NS	AQV224NS	Remarks
	LED forward current	lF			50 mA	0750	
Input	LED reverse voltage	VR			3 V		
	Peak forward current	IFP		1 A		f = 100 Hz, Duty factor = 0.1%	
	Power dissipation	Pin		75 mW			
Output	Load voltage (peak AC)	VL		80 V	200 V	400 V	
	Continuous load current	MICON	A	0.12 A	0.05 A	0.04 A	
			В	0.15 A	0.06 A	0.05 A	A connection: Peak AC, DC B, C connection: DC
	PLET IND M.		С	0.25 A	0.08 A	0.06 A	B, C connection. DC
	Peak load current	I <sub>peak</sub>		0.36 A	0.15 A	0.12 A	A connection: 100 ms (1 shot), $V_L = DC$
	Power dissipation	Pout			450 mW		
Total power dissipation		P⊤		500 mW			
I/O isolation voltage		Viso		1,500 V AC			
Temperature	Operating	Торг		<b>−40°C to +85°C</b> −40°F to +185°F			Non-condensing at low temperatures
limits	Storage	T <sub>stg</sub>		-40°C to +100°C -40°F to +212°F			

### AQV22ONS

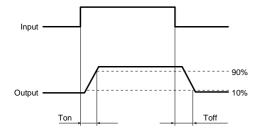
2. Electrical characteristics (Ambient temperature: 25°C 77°F)

ltem			Symbol	Type of connection	AQV225NS	AQV227NS	AQV224NS	Remarks
Input	LED aparata gurrant	Typical	<b>I</b> Fon	_	0.7 mA			- I∟ = Max.
	LED operate current	Maximum			3 mA			
	LED turn off current	Minimum	Foff	_	0.4 mA			l∟ = Max.
	LED turn on current	Typical			0.65 mA			
	LED dropout voltage	Typical	VF	_	1.14 V (1.25 V at I <sub>F</sub> = 50 mA)			I <sub>F</sub> = 5 mA
	LLD dropout voltage	Maximum			1.5 V			
Output	On resistance	Typical	Ron	A	$7.0~\Omega$	30 Ω	70 Ω	$I_F = 5 \text{ mA}$ $I_L = \text{Max.}$ Within 1 s on time
		Maximum			10.0 Ω	50 Ω	100 Ω	
		Typical	D	В	3.5 Ω	16 Ω	55 Ω	I <sub>F</sub> = 5 mA I <sub>L</sub> = Max. Within 1 s on time
		Maximum	Ron		5.0 Ω	25 Ω	70 Ω	
		Typical	Ron	С	1.8 Ω	8 Ω	28 Ω	I <sub>F</sub> = 5 mA I <sub>L</sub> = Max. Within 1 s on time
		Maximum			2.5 Ω	12.5 Ω	35 Ω	
		Typical			10 pF			I <sub>F</sub> = 0 V <sub>B</sub> = 0 f = 1 MHz
	Output capacitance	Maximum	Cout		15 pF			
	Off state leakage augreent	Typical	lleak	_	30 pA	30 pA	90 pA	IF = 0
	Off state leakage current	Maximum	lleak		10 nA			V∟ = Max.
Transfer characteristics	Turn on time*	Typical	Ton	_	0.25 ms			I <sub>F</sub> = 5 mA I <sub>L</sub> = Max.
	Turri ori time	Maximum			0.5 ms			
	Turn off time*	Typical	- T <sub>off</sub>	_	0.08 ms			I <sub>F</sub> = 5 mA I <sub>L</sub> = Max.
	Tarri on time	Maximum			0.2 ms			
	I/O capacitance	Typical	Ciso	_	0.8 pF			f = 1 MHz Vв = 0
	·	Maximum			1.5 pF			
	Initial I/O isolation resistance	Minimum	Riso		1,000 ΜΩ			500 V DC

Note: Recommendable LED forward current I<sub>F</sub>= 5 mA.

For type of connection, see Page 31.





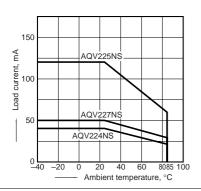
- **■** For Dimensions, see Page 28.
- For Schematic and Wiring Diagrams, see Page 31.
- For Cautions for Use, see Page 36.

#### REFERENCE DATA

1. Load current vs. ambient temperature characteristics

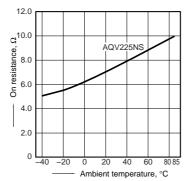
Allowable ambient temperature: -40°C to +85°C -40°F to +185°F

Type of connection: A



2.-(1) On resistance vs. ambient temperature characteristics

Measured portion: between terminals 4 and 6; LED current: 5 mA; Load voltage: Max. (DC); Continuous load current: Max. (DC)

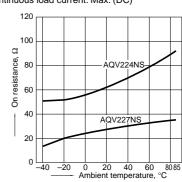


2.-(2) On resistance vs. ambient temperature characteristics

Measured portion: between terminals 4 and 6;

LED current: 5 mA;

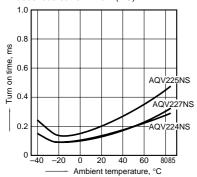
Load voltage: Max. (DC); Continuous load current: Max. (DC)



3. Turn on time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: Max. (DC);

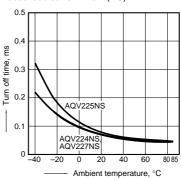
Continuous load current: Max. (DC)



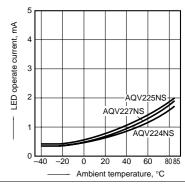
4. Turn off time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: Max. (DC);

Continuous load current: Max. (DC)

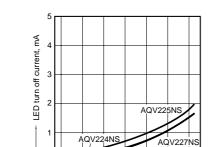


5. LED operate current vs. ambient temperature characteristics Load voltage: Max. (DC); Continuous load current: Max. (DC)



6. LED turn off current vs. ambient temperature characteristics

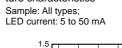
Load voltage: Max. (DC); Continuous load current: Max. (DC)

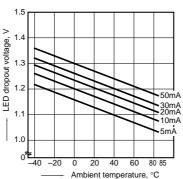


20 40 60

Ambient temperature.

7. LED dropout voltage vs. ambient temperature characteristics

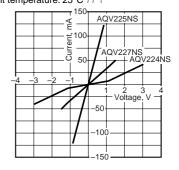




8. Voltage vs. current characteristics of output at MOS portion

Measured portion: between terminals 5 and 6, 7 and 8:

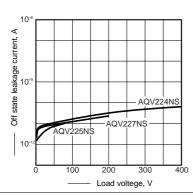
Ambient temperature: 25°C 77



9. Off state leakage current

-20

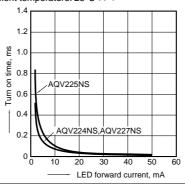
Measured portion: between terminals 4 and 6; Ambient temperature: 25°C 77°F



10. LED forward current vs. turn on time characteristics

Measured portion: between terminals 4 and 6; Load voltage: Max. (DC);

Continuous load current: Max. (DC); Ambient temperature: 25°C 77°F

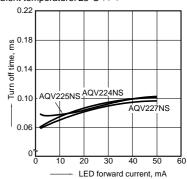


11. LED forward current vs. turn off time characteristics

Measured portion: between terminals 4 and 6; Load voltage: Max. (DC);

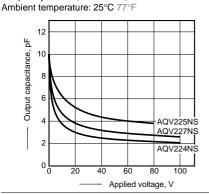
Continuous load current: Max. (DC);

Ambient temperature: 25°C 77°F



12. Applied voltage vs. output capacitance characteristics

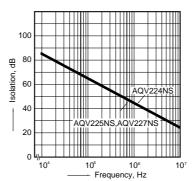
Measured portion: between terminals 4 and 6; Frequency: 1 MHz, 30 mVrms;



13. Isolation characteristics (50  $\Omega$  impedance)

Measured portion: between terminals 4 and 6;

Ambient temperature: 25°C 77°F



14. Insertion loss characteristics (50  $\Omega$  impedance)

Measured portion: between terminals 4 and 6; Ambient temperature: 25°C 77°F

